

<b>PATENT ASSIGNMENT COVER SHEET</b>
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EPAS ID: PAT2980164

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TOM KINSLEY	07/27/2005
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Micron Technology, Inc.
<b>Street Address:</b>	8000 So. Federal Way
<b>City:</b>	Boise
<b>State/Country:</b>	IDAHO
<b>Postal Code:</b>	83716-9632
<b>PROPERTY NUMBERS Total: 3</b>	
<b>Property Type</b>	<b>Number</b>
<b>Patent Number:</b>	8030952
<b>Patent Number:</b>	8692568
<b>Application Number:</b>	14231864
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	303.908US*
<b>NAME OF SUBMITTER:</b>	LISA M. LEE
<b>SIGNATURE:</b>	/Lisa M. Lee/
<b>DATE SIGNED:</b>	08/13/2014
<b>Total Attachments: 2</b>	
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source=303908us1 Assignment#page2.tif	

## ASSIGNMENT

WHEREAS, I, Tom Kinsley, residing at 83 Kirk Dr., Boise, ID 83716, made certain new and useful inventions and improvements for which I executed an application for Letters Patent of the United States on even date herewith, which is entitled POWER SINK FOR IC TEMPERATURE CONTROL;

AND WHEREAS, Micron Technology, Inc., a corporation organized and existing under and by virtue of the laws of the State of Delaware, and having an office and place of business at 8000 So. Federal Way, Boise, ID 83716-9632 (hereinafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, I have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent which may be granted there from, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted there from; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, I do hereby agree that I and my executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to me relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

